

News Release

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EPOXIBONDTM EB-153 – FiberOptic, Electronic Adhesive



P^{poxy}S^{et} introduces the EPOXIBOND™ EB-153, high temperature epoxy. Originally developed for fiber optic cable assembly, this heat cure epoxy is a choice product for electronic bonding applications as well as for sealing and coating requirements.

This two-part system can be cured as quickly as one minute @ 150°C. It has a low-medium viscosity with a 5-6 hour work time at room temperature. The high

technology formulation includes a cure indicator that changes color from clear yellow (uncured) to dark red (cured).

Once cured, this epoxy produces a Glass Transition temperature of 115°C and can be used up to 250°C continuously. It passes continuous exposure to 85/85 testing as well as temperature cycling from -40 to 125°C. The EB-153 produces a high dielectric strength with a low dissipation factor of .006 @ 1KhZ. The volume resistivity of 10¹⁵ ohm-cm makes it an excellent electrical insulator. It also provides exceptional chemical and environmental resistance.

 $e^{poxy}S^{et}$ is an innovative custom formulator of Epoxies, Urethanes, Silicones, Thermal Greases and UV cures for the electronic, medical, semi-conductor, optics, automotive and aerospace industries. Our extensive experience allows us to quickly modify our wide-ranging product line for any requirement. Please contact our technical support staff at 401-726-4500

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